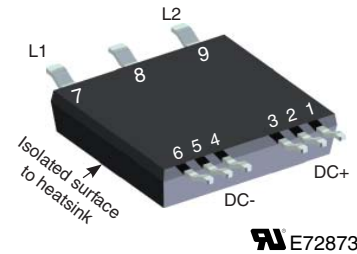
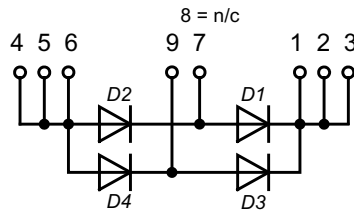


High Efficiency Standard Rectifier

Single Phase Rectifier Bridge

$V_{RRM} = 1200\text{ V}$
 $I_{DAV} = 124\text{ A}$
 $V_F = 1.15\text{ V}$



Diodes		Characteristic Values				
Symbol	Conditions					
		min.	typ.	max.		
V_{RRM}				1200	V	
I_R	$V_R = 1200\text{ V}$			10	μA	
				0.1	mA	
V_F	$I_F = 50\text{ A}$ $I_F = 100\text{ A}$			1.23	V	
				1.45	V	
	$I_F = 50\text{ A}$ $I_F = 100\text{ A}$			1.15	V	
				1.44	V	
I_{DAV}	rectifier output current with: rect. d = 0.5 (per diode) sine 180° (per diode)			132	A	
		$T_C = 80^\circ\text{C}$		124	A	
V_{F0}	} for power loss calculation only $T_{VJ} = 175^\circ\text{C}$			0.75	V	
r_F				4.2	$\text{m}\Omega$	
R_{thJC}				1.0	K/W	
R_{thJH}	with thermal transfer paste (IXYS test setup)		1.45	1.6	K/W	
T_{VJ}		-55		175	$^\circ\text{C}$	
P_{tot}				150	W	
I_{FSM}	$t = 10\text{ ms}; (50\text{ Hz}), \text{ sine}$ $t = 8.3\text{ ms}; (60\text{ Hz}), \text{ sine}$	$T_{VJ} = 45^\circ\text{C}$		400	A	
		$V_R = 0\text{ V}$		430	A	
	$t = 10\text{ ms}; (50\text{ Hz}), \text{ sine}$ $t = 8.3\text{ ms}; (60\text{ Hz}), \text{ sine}$	$T_{VJ} = 150^\circ\text{C}$		350	A	
		$V_R = 0\text{ V}$		375	A	
I^2t	$t = 10\text{ ms}; (50\text{ Hz}), \text{ sine}$ $t = 8.3\text{ ms}; (60\text{ Hz}), \text{ sine}$	$T_{VJ} = 45^\circ\text{C}$		800	A^2s	
		$V_R = 0\text{ V}$		780	A^2s	
	$t = 10\text{ ms}; (50\text{ Hz}), \text{ sine}$ $t = 8.3\text{ ms}; (60\text{ Hz}), \text{ sine}$	$T_{VJ} = 150^\circ\text{C}$		610	A^2s	
		$V_R = 0\text{ V}$		570	A^2s	
C_J	$V_R = 1200\text{ V}; f = 1\text{ MHz}$	$T_{VJ} = 25^\circ\text{C}$	13		pF	

Features

- Planar passivated chips
- Very low leakage current
- Very low forward voltage drop
- Improved thermal behaviour

Applications

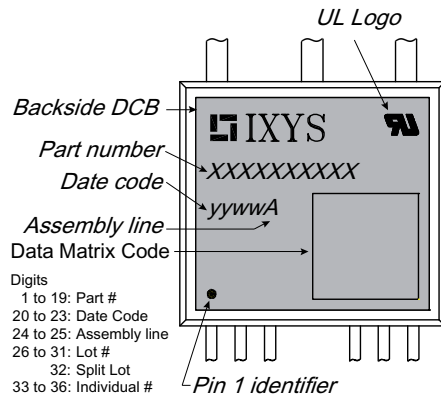
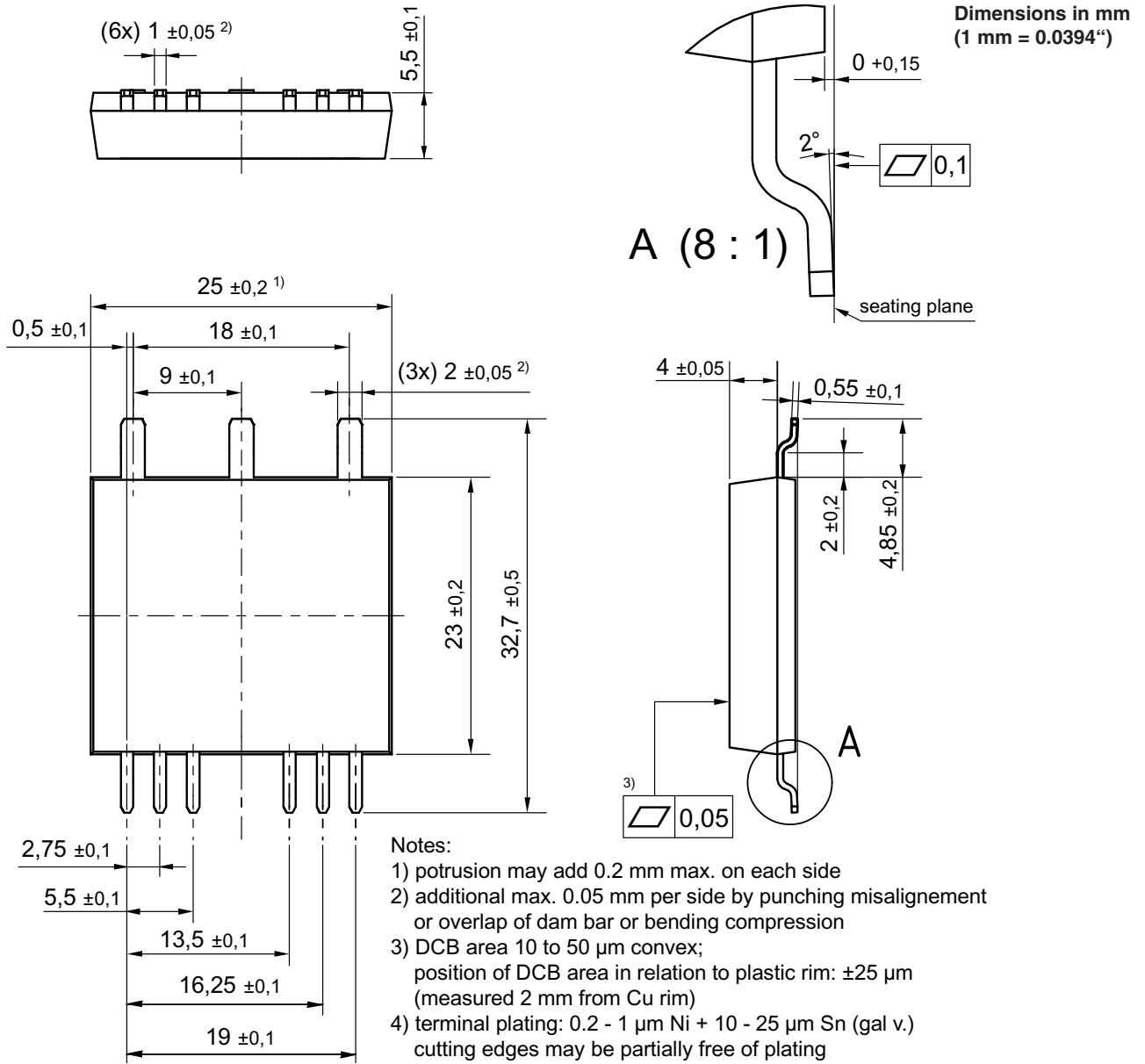
- Diode Bridge for main rectification

Package

- DCB isolated backside
- Isolation Voltage 3000 V
- Epoxy meets UL 94V-0
- RoHS compliant

Component					
Symbol	Conditions	Characteristic Values			
		min.	typ.	max.	
I_{RMS}	wide pin			100	A
	standard pin			60	A
T_{stg}		-55		150	°C
Weight			8		g
F_C		40		130	N
V_{ISOL}	t = 1 second		3000		V
	t = 1 minute		2500		V
d_S, d_A	pin - pin	1.65			mm
d_S, d_A	pin - backside metal	4			mm

Ordering	Ordering Name	Marking on Product	Delivering Mode	Base Qty	Ordering Code
Standard	DLA100B1200LB-TRR	DLA100B1200LB	T&R	200	509901
	DLA100B1200LB	DLA100B1200LB	Blister	45	510245



Example: DLA100B1200LB000000001028A24597300000

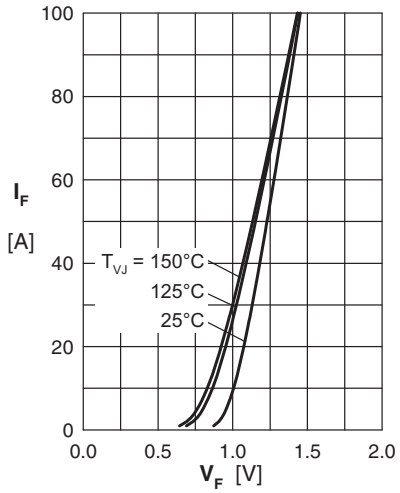


Fig. 1 Forward current versus voltage drop per diode

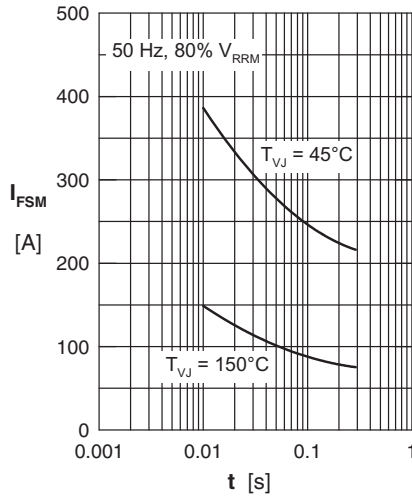


Fig. 2 Surge overload current

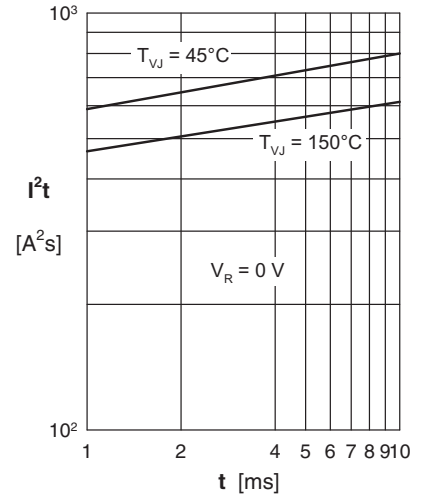


Fig. 3 I^2t versus time per diode

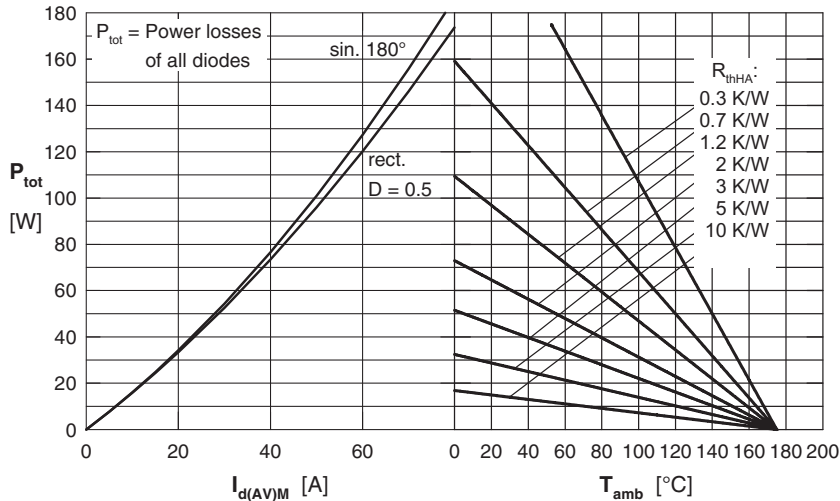


Fig. 4 Power dissipation vs. bridge output current and ambient temperature

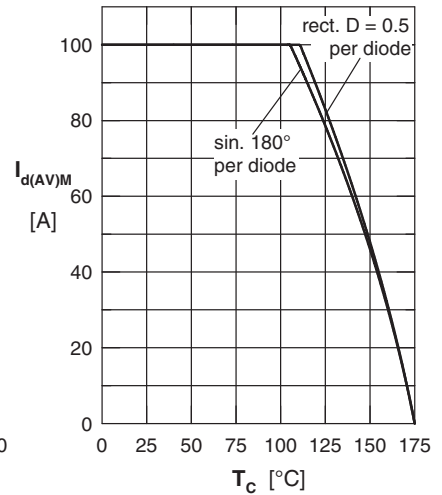


Fig. 5 Max. bridge output current vs. case temperature

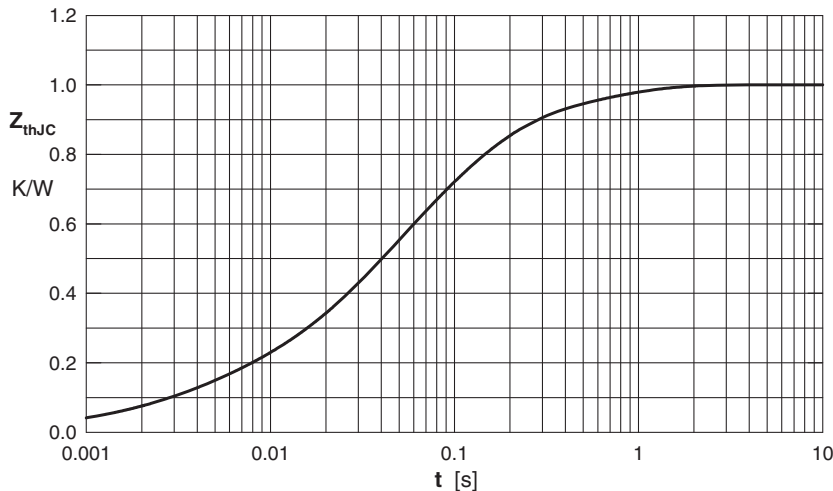


Fig. 6 Transient thermal impedance junction to case

Constants for Z_{thJC} calculation:

i	R_{thi} [K/W]	t_i [s]
1	0.09	0.003
2	0.116	0.062
3	0.386	0.1
4	0.128	0.55